TOSHIBA Field Effect Transistor Silicon P Channel MOS Type ($L^2-\pi$ -MOSV)

2SJ438

DC-DC Converter, Relay Drive and Motor Drive Applications

• 4-V gate drive

• Low drain-source ON resistance : $R_{DS(ON)} = 0.16 \Omega$ (typ.)

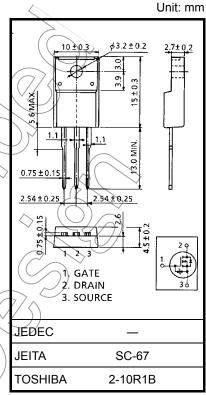
• High forward transfer admittance : $|Y_{fs}| = 4.0 \text{ S (typ.)}$

• Low leakage current : $I_{DSS} = -100 \mu A \text{ (max)} (V_{DS} = -60 \text{ V})$

• Enhancement mode : $V_{th} = -0.8$ to -2.0 V ($V_{DS} = -10$ V, $I_D = -1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	-60	V
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	-60	V
Gate-source voltage		V_{GSS}	±20	> ∨
Drain current	DC (Note 1)	ΙD	-5	Α
	Pulse(Note 1)	I _{DP}	-20	A
Drain power dissipation	n (Tc = 25°C)	PD	25	/ (w
Single pulse avalanche	e energy (Note 2)	E _A \$	273	mJ
Avalanche current		TAR	-5	A
Repetitive avalenche e	nergy (Note 3)	(EAR))	2	/mJ
Channel temperature		Tch	150	~c
Storage temperature ra	ange	T _{stg}	-55~150	°C



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	5.0	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = -25 V, T_{ch} = 25°C (initial), L = 14.84 mH, R_G = 25 Ω , I_{AR} = -5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

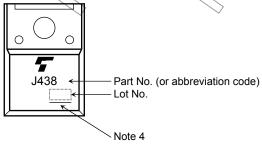
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	_	_	-100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = -10 mA, V _{GS} = 0 V	-60	_	_	V
Gate threshold v	oltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	V
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = -4 V, I _D = -2.5 A	(F	0.24	0.28	Ω
			V _{GS} = -10 V, I _D = -2.5 A	\nearrow	0.16	0.19	
Forward transfer	r admittance	Y _{fs}	V _{DS} = -10 V, I _D = -2.5 A	2.0	4.0	_	S
Input capacitano	e	C _{iss}		_	630	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	95	_	pF
Output capacitance		Coss		_	290		
Switching time	Rise time	t _r	V _{GS} OV T I _D = -2.5A V _{OUT}	- (25	\(\sigma\) \(\rac{1}{\sigma}\)	
	Turn-on time	t _{on}	$V_{GS} \stackrel{OV}{\longrightarrow} \qquad \qquad V_{OUT} \stackrel{OV}{\longrightarrow} \qquad \qquad R_{L} = \qquad $		45) —	
	Fall time	t _f	V _{DD} = -30V	7 (5)	55	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\mathbf{W}} = 10 \mu s$		200	_	
Total gate char plus gate-drain)	ge (Gate-source	Qg		_	22	ı	
Gate-source charge		Q _{gs}	$V_{DD} \approx -48 \text{ V}, V_{GS} = -10 \text{ V}, V_{D} = -5 \text{ A}$		16		nC
Gate-drain ("mil	ler") charge	Qgd		_	6	_	

Source-Drain Ratings and Characteristics (Ta ≠25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	1 _{DR}		_	_	-5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	-20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = -5 A, V _{GS} = 0 V	_	_	1.7	V
Reverse recovery time	t _{rr}	I _{DR} = -5 A, V _{GS} = 0 V dI _{DR} / dt = 50 A / μs	_	80	_	ns
Reverse recovery charge	Q _{rr}	1DR - 3 Λ, VGS - 0 V α1DR / αι - 30 Α / μS	_	0.1	_	μC

Marking

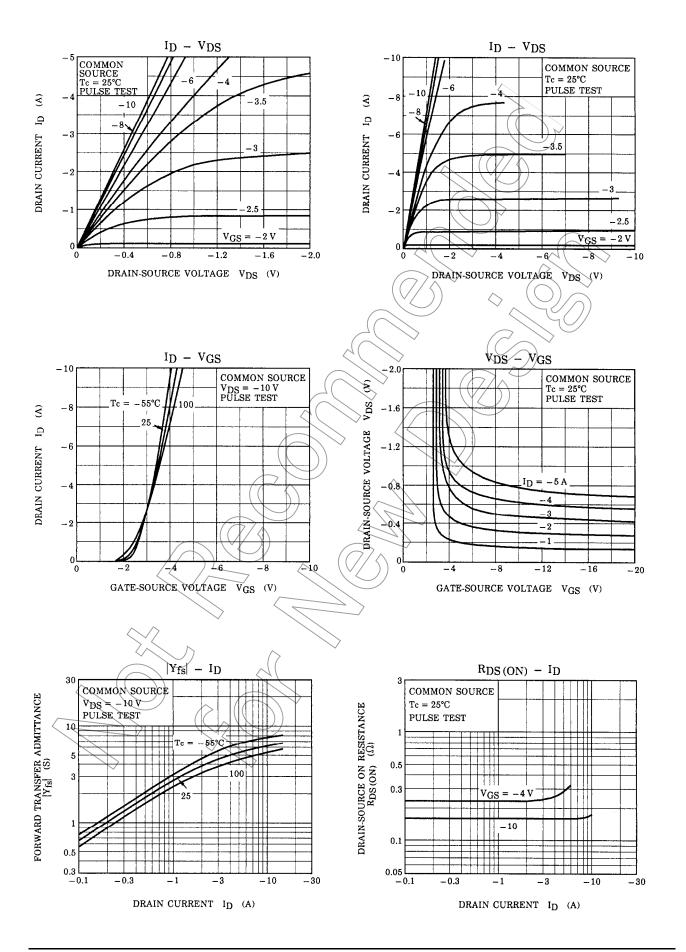


Note 4: A line under a Lot No. identifies the indication of product Labels.

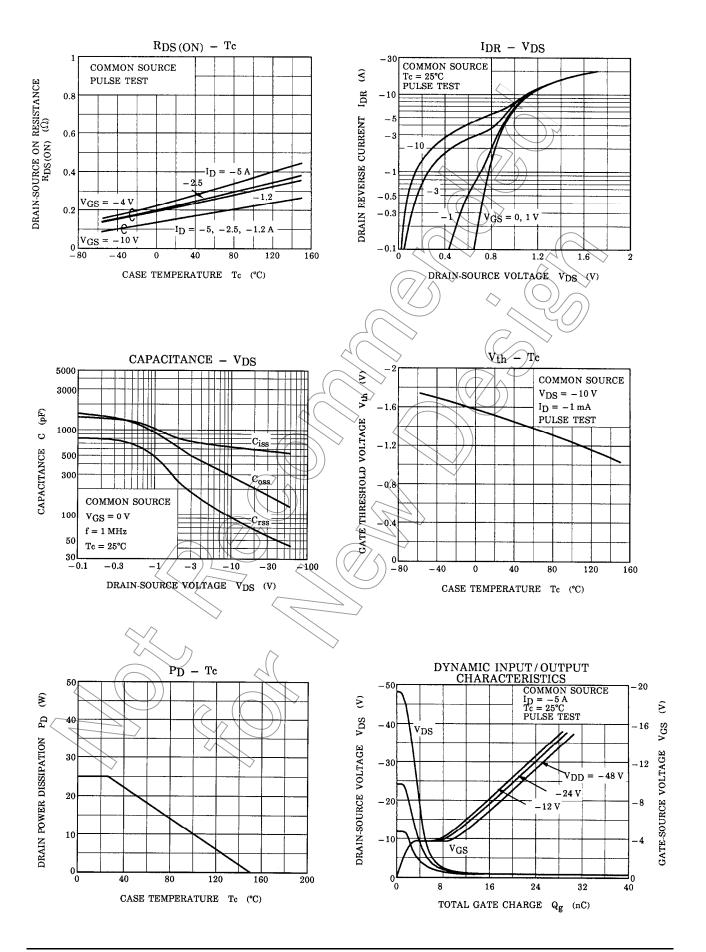
Not underlined: [[Pb]]/INCLUDES > MCV

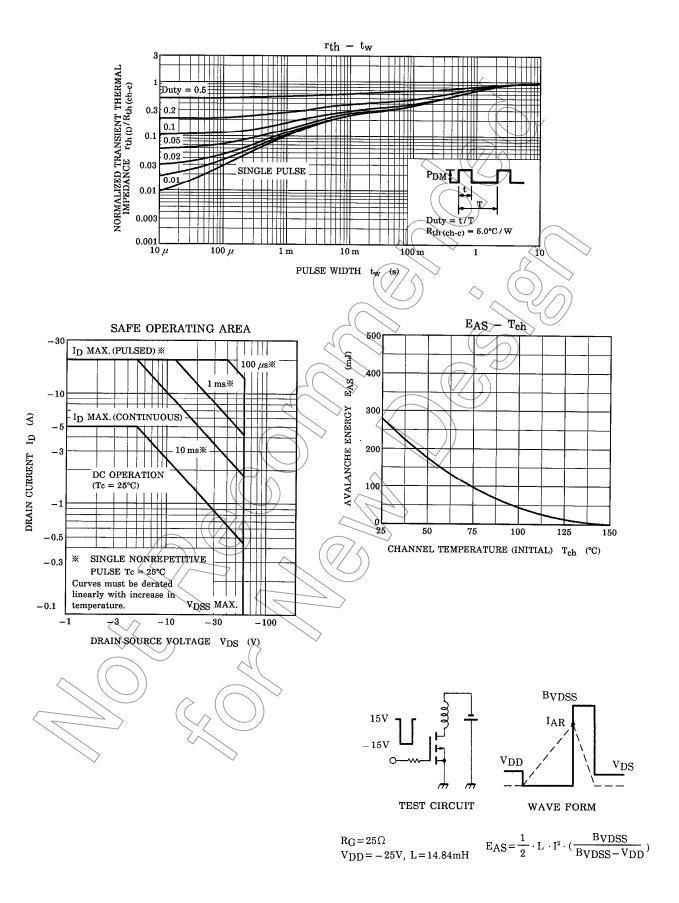
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



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